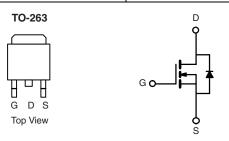


Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0017			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0020			
I _D (A)	120			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- AEC-Q101 Qualified^d
- Compliant to RoHS Directive 2002/95/EC
- Find out more about Vishay's Automotive Grade Product Requirements at: www.vishay.com/applications



ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free and Halogen-free	SQM120N04-1M7L-GE3

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	40	V	
Gate-Source Voltage		V_{GS}	± 20	7 v	
Continuous Drain Current ^a	T _C = 25 °C	1	120		
	T _C = 125 °C	l _D	120		
Continuous Source Current (Diode Conduction) ^a		Is	120	А	
Pulsed Drain Current ^b		I _{DM}	465		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	90		
Single Pulse Avalanche Energy		E _{AS}	405	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	437.5	W	
	T _A = 25 °C	L L D	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R_{thJC}	0.4	O/W	

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

SQM120N04-1M7L

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SPECIFICATIONS $T_C = 25 ^{\circ}C$,	unless otherw	ise noted					
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static	•	•					
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	2.5	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1.0	
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50	μΑ
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	250	•
On-State Drain Currenta	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	120	-	-	Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 30 A	-	0.0013	0.0017	
	В	V _{GS} = 10 V	I _D = 30 A, T _J = 125 °C	-	-	0.0027	Ω
	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	-	0.0032	122
		V _{GS} = 4.5 V	I _D = 20 A	-	0.00145	0.0020	1
Forward Transconductance ^a	9 _{fs}	V_{DS}	= 15 V, I _D = 30 A	-	210	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = 20 V, f = 1 MHz	-	18 800	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	1550	-	
Reverse Transfer Capacitance	C _{rss}			-	850	-	
Total Gate Charge ^c	Qg	V _{GS} = 10 V	V V _{DS} = 20 V, I _D = 20 A	-	240	-	nC
Gate-Source Charge ^c	Q_{gs}			-	40	-	
Gate-Drain Charge ^c	Q_{gd}			-	22	-	
Turn-On Delay Time ^c	t _{d(on)}				100	-	
Rise Time ^c	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_L = 1 \Omega$ $I_D \cong 20 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$		-	62	-	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	180	-	
Fall Time ^c	t _f			-	60	-	
Source-Drain Diode Ratings and Char	acteristics T _C = 2	5 °Cb					
Pulsed Current ^a	I _{SM}			-	-	250	Α
Forward Voltage	V _{SD}	I _F = 85 A, V _{GS} = 0 V		-	1.1	1.5	V

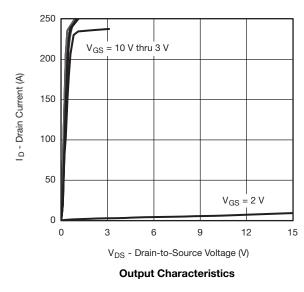
Notes

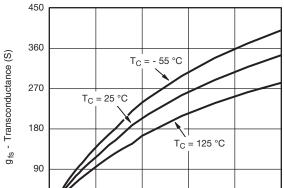
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted





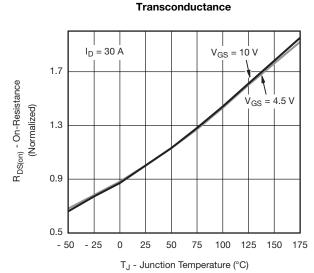
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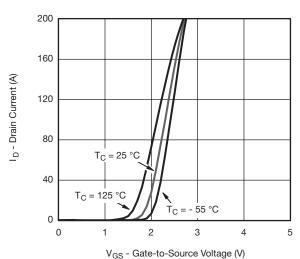
I_D - Drain Current (A)

56

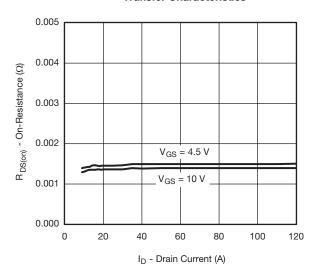
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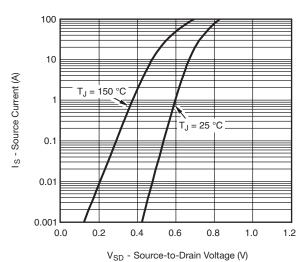




Transfer Characteristics



On-Resistance vs. Drain Current



Source Drain Diode Forward Voltage

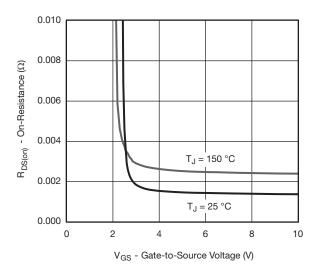
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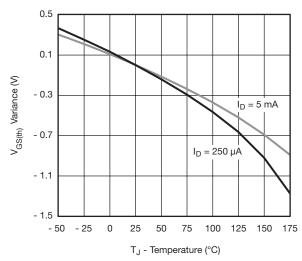
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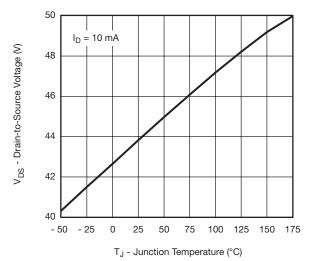
TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted





On-Resistance vs. Gate-to-Source Voltage

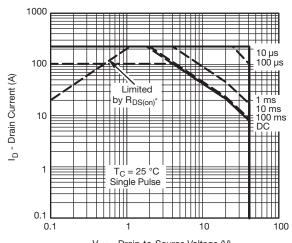
Threshold Voltage



Drain Source Breakdown vs. Junction Temperature

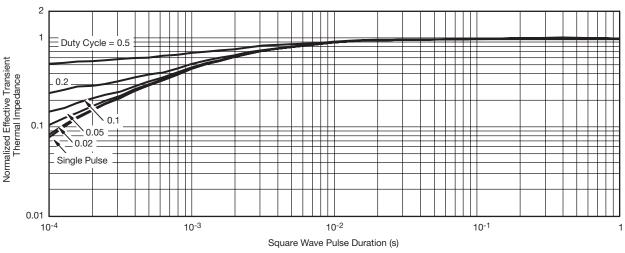


THERMAL RATINGS T_A = 25 °C, unless otherwise noted



 $V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^*V_{GS} > \text{minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified}$

Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the graph is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65729.





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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com